

60V Normally Open (1-Form-A) Optical MOSFET Relay

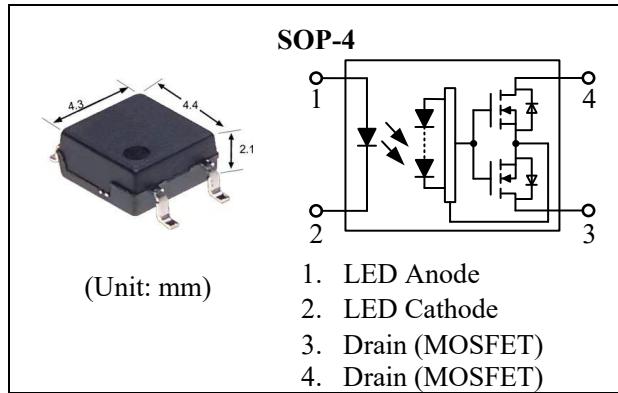
General Features

- Low-level off State Leakage Current
- No Moving Parts
- Fast Switching Speed
- 1500 Vrms Input/Output Isolation
- SOP Package 4 Pin Type in Miniature Design
- Highly Efficient GaAlAs Infrared LED and High-Reliability MOSFETs

V_{OFF}	I_{ON}	R_{ON(TYP.)}
60V	200mA	3Ω

Application

- Telecommunications
- Measurement Equipment
- Industrial Automation
- Control Equipment
- Medical equipment
- I/O Sub-Systems



Ordering Information

Part Number	Package	Marking	Packing Quantity
OPY212S1	SOP-4	OPY212S1	2000pcs/Reel

Absolute Maximum Ratings

T_A=25°C unless otherwise specified

Item	Symbol	Note	Value	Unit
Input	I _F	--	50	mA
	I _{FP}	f = 100Hz, duty = 1%	1000	mA
	V _R	--	5	V
	P _D	--	75	mW
Output	V _{OFF}	AC Peak or DC	60	V
	I _{ON}	--	200	mA
	I _{ONP}	100ms (1 pulse)	600	mA
	P _O	--	380	mW
Total Power Dissipation	P _T	--	450	mW
Storage Temperature	T _{stg}	--	-40 to 100	°C
Operating Temperature	T _{opr}	--	-40 to 85	°C
Lead Soldering Temperature	T _{sol}	10 sec max.	260	°C
Isolation Voltage ^[1]	BV _{IO}	AC, RH ≤ 60%, 60s	1500	Vrms

Caution: Stresses beyond those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.

Electrical Characteristics

 $T_A=25^\circ\text{C}$ unless otherwise specified

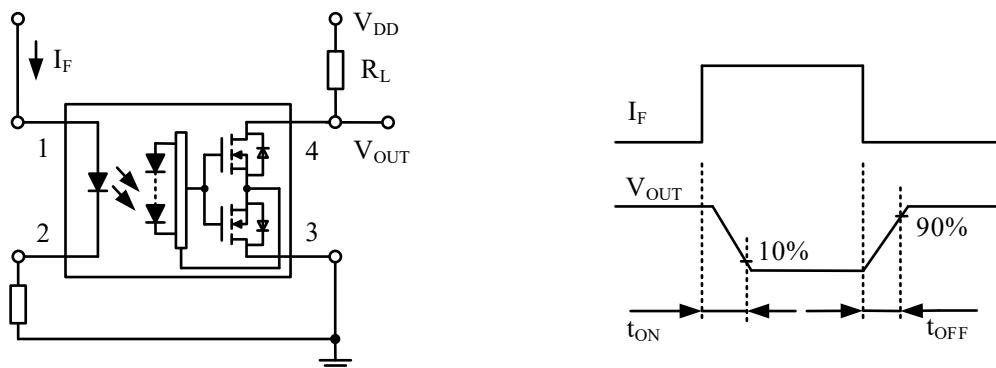
Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input	LED Forward Voltage	V_F	--	1.3	1.4	V	$I_F = 10\text{mA}$
	LED Reverse Current	I_R	--	--	5.0	μA	$V_R = 5\text{V}$
	Trigger LED Current	I_{FT}	--	0.5	2.0	mA	$I_{ON} = 100\text{mA}$
	Return LED Current	I_{FC}	0.2	0.35	--	mA	$I_{OFF} = 100\mu\text{A}$
Output	On-state Resistance [2]	R_{ON}	--	3	5	Ω	$I_F = 5\text{mA}, I_{ON} = 100\text{mA}$
	Off-state Leakage Current	I_{OFF}	--	--	1.0	μA	$V_{OFF} = 60\text{V}$
	Output Capacitance	C_{OUT}	--	12	--	pF	$V_{OFF} = 0\text{V}, f = 1\text{MHz}$
Transmission	Turn-on Time [3]	T_{ON}	--	80	500	μs	$I_F = 5\text{mA}, I_{ON} = 100\text{mA}$
	Turn-off Time [3]	T_{OFF}	--	50	500	μs	
Coupled	Capacitance Input to Output	C_{IO}	--	0.8	1.5	pF	$f = 1\text{MHz}$
	Isolation Resistance	R_{IO}	10^{10}	--	--	Ω	DC = 500V

NOTE:

[1] LED pins are shorted together. Detector pins are also shorted together.

[2] Measurement Taken within 1 Second of On-time.

[3] Switching Time Test Circuit.



Typical Device Performance

Figure 1. Load Current vs. Ambient Temperature

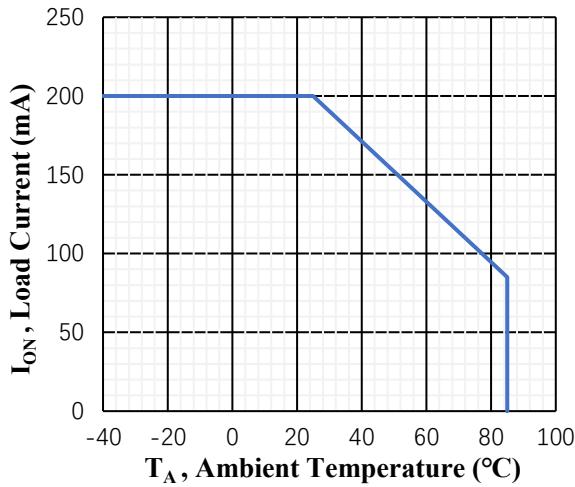


Figure 3. Switching Time vs. Ambient Temperature

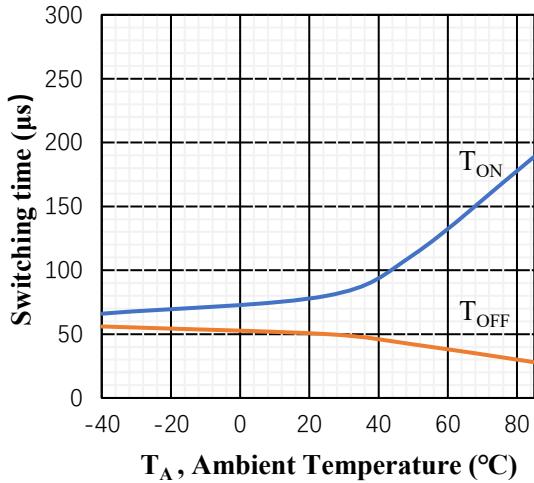


Figure 5. LED forward Voltage Vs. Ambient Temperature

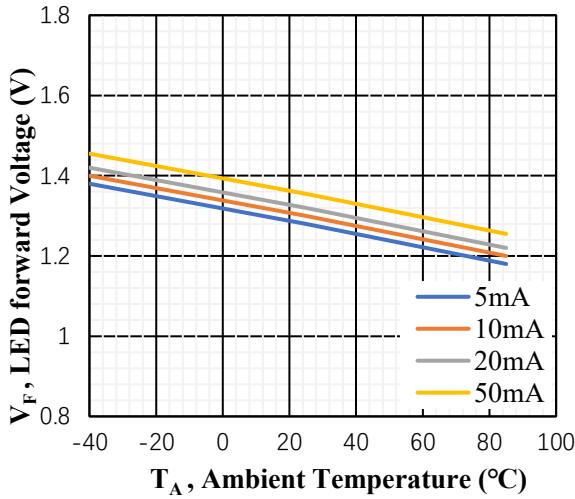


Figure 2. On-state Resistance vs. Ambient Temperature

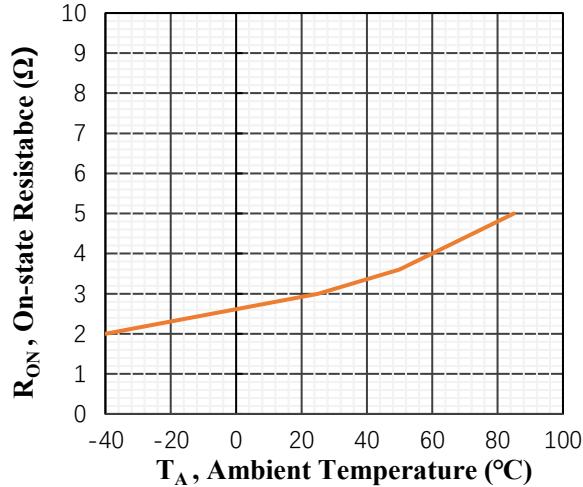


Figure 4. Trigger LED Current vs. Ambient Temperature

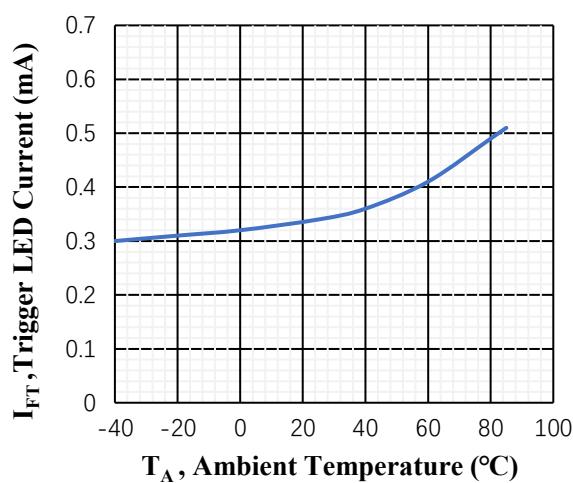
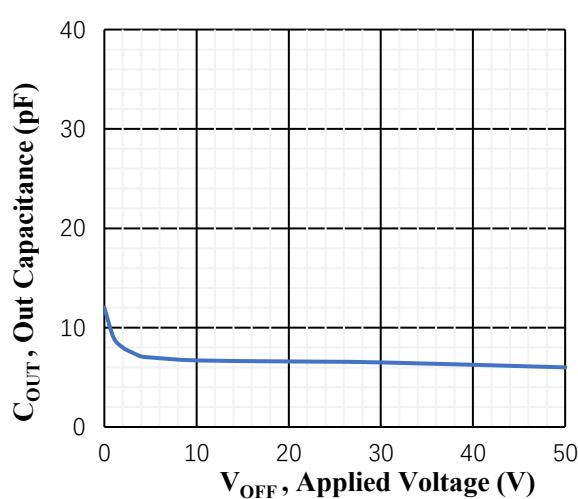
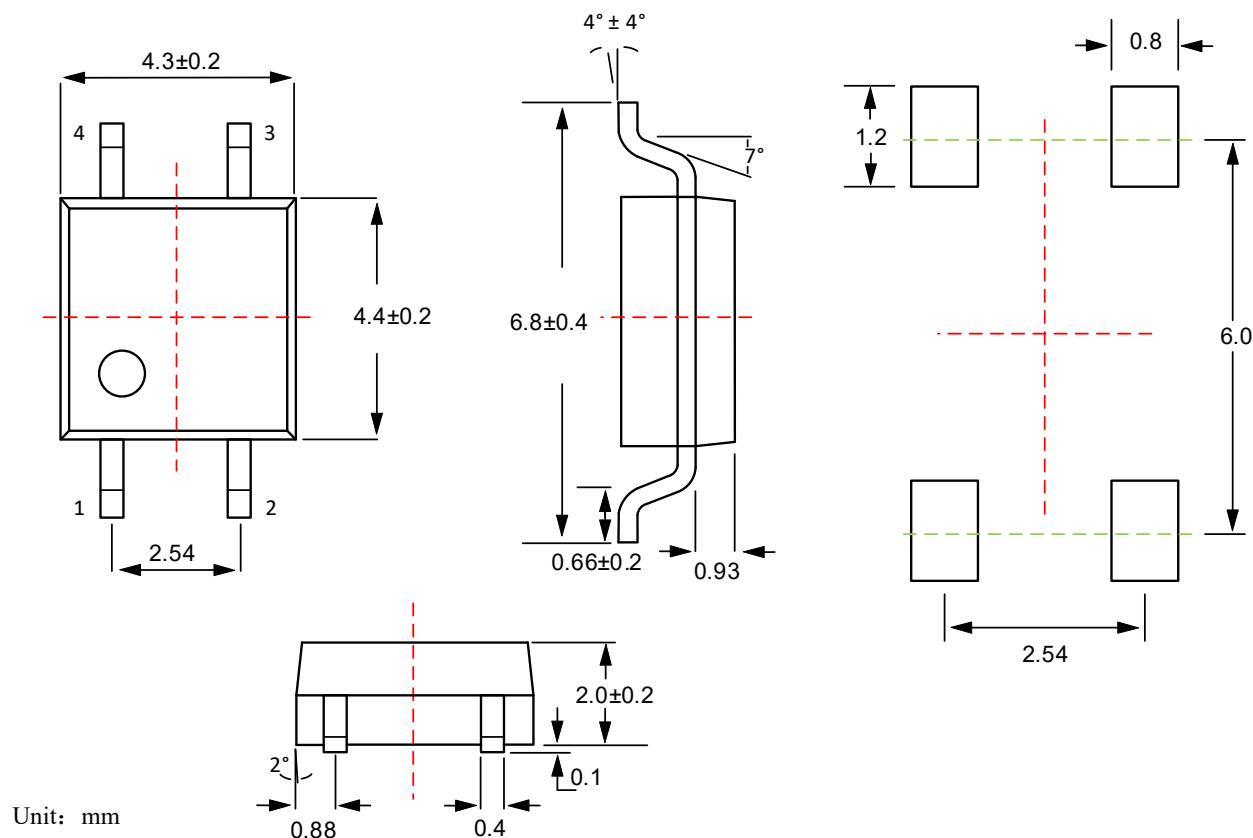


Figure 6. Output Capacitance Vs. Applied Voltage



Package Dimensions

SOP - 4



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